

3.2x2.4mm SMD CHIP LED LAMP

Features

- 3.2x2.4mm SMT LED,2.4mm THICKNESS.
- LOW POWER CONSUMPTION.
- \bullet IDEAL FOR BACK LIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 1500PCS / REEL.
- \bullet MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

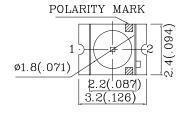


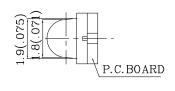


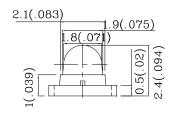
Notes:

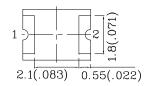
- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		SG (InGaAlP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	IF	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	150	mA	
Power Dissipation	Рт	75	mW	
Operating Temperature	TA	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		









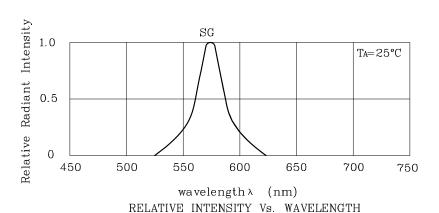
Operating Characteristics (TA=25°C)		SG (InGaAlP)	Unit
Forward Voltage (Typ.) (IF=20mA)	VF	2.1	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	574	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	26	nm
Capacitance (VF=0V, f=1MHz)	С	20	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.		
ZSG78W	Green	InGaAlP	Water Clear	280	547	574	20°
Published Date : F	EB 26, 2008	Drawing No	o : SDSA1636	V5	Check	ed : B.L.LIU	P.1/4

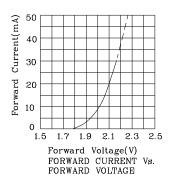


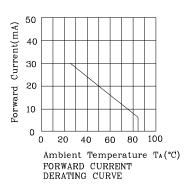
Part Number: ZSG78W

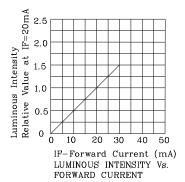
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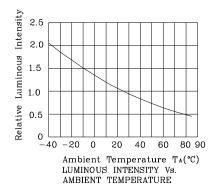


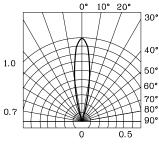
❖ SG











SPATIAL DISTRIBUTION

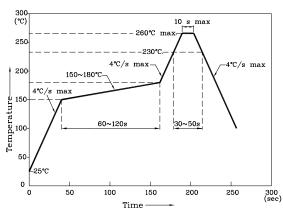
Published Date : FEB $\,26,\,2008$ Drawing No : SDSA1636 V5 Checked : B.L.LIU P.2/4



Part Number: ZSG78W

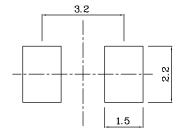
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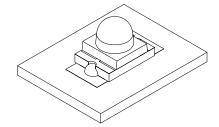
Reflow Soldering Profile For Lead-free SMT Process.



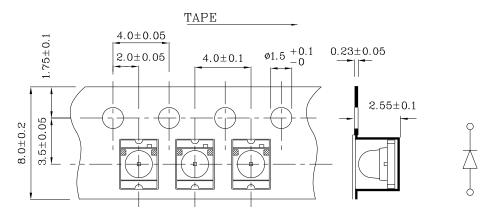
NOTES:

- 1. Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- 3. Do not put stress to the epoxy resin during high temperatures conditions.
- **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
- ❖ The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

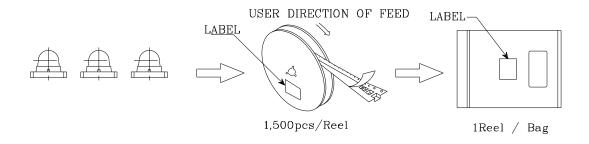


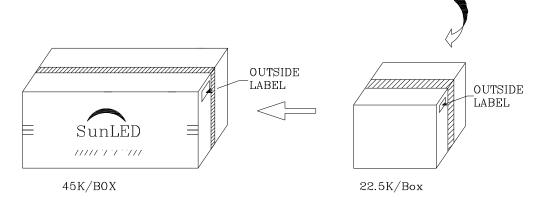
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PACKING & LABEL SPECIFICATIONS

ZSG78W







QTY: 1,500 pes CODE: XXX

S/N : XX

LOT NO:



RoHS Compliant

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